EP 1 241 706 A3

(12)

EUROPEAN PATENT APPLICATION

- (88) Date of publication A3: 18.02.2004 Bulletin 2004/08
- (43) Date of publication A2: 18.09.2002 Bulletin 2002/38
- (21) Application number: 02005780.8
- (22) Date of filing: 13.03.2002

- (51) Int CI.7: **H01L 21/68**, H01L 23/467, H02N 13/00, C23F 1/08, H01L 21/00
- (84) Designated Contracting States:

 AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU

 MC NL PT SE TR

 Designated Extension States:

 AL LT LV MK RO SI
- (30) Priority: 13.03.2001 US 808210

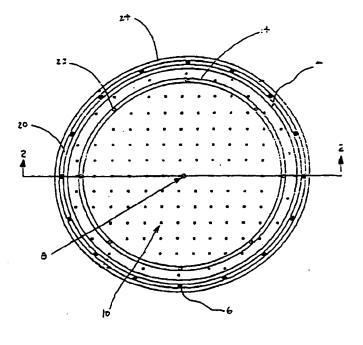
- (71) Applicant: NIKON CORPORATION Tokyo 100-0005 (JP)
- (72) Inventor: Sogard, Michael Menlo Park, CA 94025 (US)

(11)

- (74) Representative: Viering, Jentschura & Partner Postfach 22 14 43 80504 München (DE)
- (54) A gas cooled electrostatic pin chuck for vacuum applications
- (57) An electrostatic pin chuck consisting of an annular array of gas inlets, located towards the periphery of the chuck, for providing a uniform distribution of cooling gas to a wafer held by the chuck. This uniform distribution of cooling gas results in a uniform transfer of heat from the wafer to the chuck. Two annular rims positioned towards the outer perimeter of the chuck, and

separated by an annular array of vacuum pumpout ports connected through a manifold to a vacuum pump, help to prevent leakages of cooling gas by functioning as gas bearing seals. Varying the annular thickness of the inner and outer rim, vacuum pump pressure, and the space between the wafer and chuck all affect the leakage rate of cooling gas from the chuck.





EP 1 241 706 A3



EUROPEAN SEARCH REPORT

Application Number EP 02 00 5780

	DOCUMENTS CONSIDERE	D IO BE RELEVANT			
Category	Citation of document with indicate of relevant passages	ion, where appropriate,	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)	
x	EP 0 790 641 A (NOVELL 20 August 1997 (1997-0 * abstract * * figure 15A * * page 10, line 12 - 1 * claim 1 *	8-20)	l-8	H01L21/68 H01L23/467 H02N13/00 C23F1/08 H01L21/00	
Y	* the whole document *	9	,10		
Y	EP 0 230 540 A (COMPAC CORP) 5 August 1987 (1 * figure 17 * * claim 3 * * the whole document * * page 17, line 10 - p	987-08-05)	3,10		
Y	WO 91 18400 A (HAMPSHI 28 November 1991 (1991 * abstract * * the whole document *	- RE INSTR INC) -11-28)	10		
	the whole document	;			
				TECHNICAL FIELDS SEARCHED (Int.CL7)	
				H01L	
				H02N	
	,			C23F	
				·	
İ					
		į			
[
-					
	The present search report has been o	trawn up for all claims			
·· -	Place of search	Date of completion of the search		Examiner	
MUNICH		16 December 2003 B		ader, K	
CATEGORY OF CITED DOCUMENTS X: particularly relevant if taken alone Y: particularly relevant if combined with another document of the same category A: technological background O: non-written disaclosurs P: intermediate document		E : earlier patent docum after the filing date D : document cited in th L : document cited for of	D : document cited in the application L : document cited for other reasons		
		& : member of the same		comenanting	

ANNEX TO THE EUROPEAN SEARCH REPORT ON EUROPEAN PATENT APPLICATION NO.

EP 02 00 5780

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

16-12-2003

Patent document cited in search report		Publication date		Patent family member(s)	Publication date
EP 0790641	A	20-08-1997	US DE EP JP JP	5810933 A 790641 TI 0790641 A1 3176305 B2 9232415 A	22-09-1998 09-04-1998 20-08-1997 18-06-2001 05-09-1997
EP 0230540	A	05-08-1987	US EP JP	4676649 A 0230540 A2 62152633 A	30-06-1987 05-08-1987 07-07-1987
WO 9118409	A	28-11-1991	US JP KR WO	5197089 A 5506543 T 9703775 B1 9118400 A1	23-03-1993 22-09-1993 21-03-1997 28-11-1991
				·	
					•

For more details about this annex: see Official Journal of the European Patent Office, No. 12/82